SHANGHAI SINO-IC
MICROELECTRONICS CO., LTD.

Mar 2015

SE1216
P-Channel Enhancement-Mode MOSFET

Revision: A

General Description

Advanced trench technology to provide excellent RDS(ON), low gate charge and low operation voltage. This device is suitable for using as a load switch or in PWM applications.

- Simple Drive Requirement
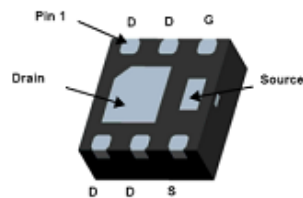- Small Package Outline
- Surface Mount Device
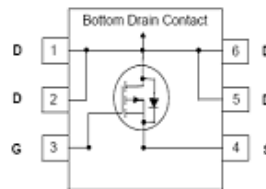
Features

For a single MOSFET

- V_{DS} = -12V
- $R_{DS(ON)}$ = 11mΩ @ V_{GS}=-4.5V
- $R_{DS(ON)}$ = 14mΩ @ V_{GS}=-2.5V

Pin configurations

See Diagram below

DFN2x2-6L Pin Assignment
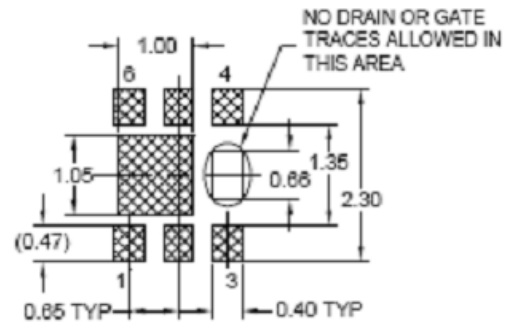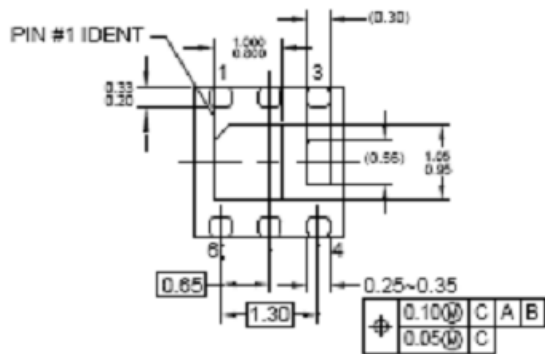

Schematic diagram

Absolute Maximum Ratings

Parameter		Symbol	Rating	Units
Drain-Source Voltage		V_{DS}	-12	V
Gate-Source Voltage		V_{GS}	±12	V
Drain Current	Continuous	I_D	-21	A
	Pulsed		-28	
Total Power Dissipation	@TA=25℃	P_D	2.4	W
Operating Junction Temperature Range		T_J	-55 to 150	℃

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Electrical Characteristics (TJ=25℃ unless otherwise noted)						
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS (Note 2)						
BV_{DSS}	Drain-Source Breakdown Voltage	I_D=250µA, V_{GS}=0 V	-12			V
I_{DSS}	Drain to Source Leakage Current	V_{DS}= -12V, V_{GS}=0V			-1	µA
I_{GSS}	Gate-Body Leakage Current	V_{GS}=12V			100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}= V_{GS}, I_D=250µA	-0.4	-0.7	-1	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance [2]	V_{GS}=-4.5V, I_D=-6.7A	-	11	18	mΩ
		V_{GS}=-2.5V, I_D=-6.2A		14	22	
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=-6V, f=1MHz	-	2138	-	pF
C_{oss}	Output Capacitance		-	685	-	pF
C_{rss}	Reverse Transfer Capacitance		-	650	-	pF
SWITCHING PARAMETERS						
Q_g	Total Gate Charge [2]	V_{GS}=-4.5V, V_{DS}=-6V, I_D=-10A	-	21	-	nC
Q_{gs}	Gate Source Charge		-	2.5	-	nC
Q_{gd}	Gate Drain Charge		-	6	-	nC
$t_{d(on)}$	Turn-On Delay Time	V_{GS}=-4.5V, V_{DS}=-6V, R_{GEN}=6Ω, I_D=-10A		30		ns
$t_{d(off)}$	Turn-Off Delay Time			97		ns
$t_{d(r)}$	Turn-On Rise Time			48		ns
$t_{d(f)}$	Turn-Off Fall Time			65		ns
Thermal Resistance						
Symbol	Parameter			Typ	Max	Units
$R_{\theta JC}$	Junction to Case			6.9	8	℃/W
$R_{\theta JA}$	Junction to Ambient (t≦10s)			52	62.5	℃/W

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Package Outline Dimension

DFN2 × 2-6L
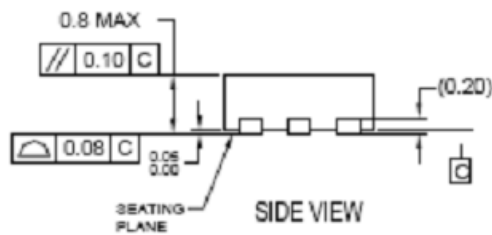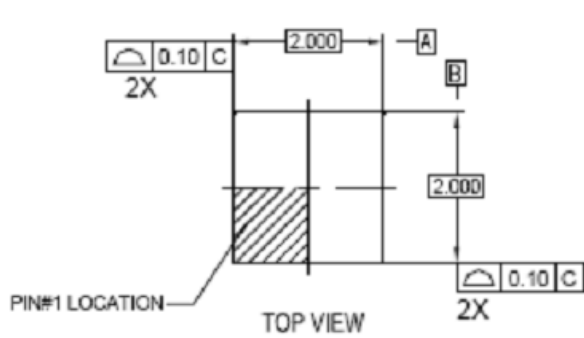
TOP VIEW

SIDE VIEW

RECOMMENDED LAND PATTERN OPT 1
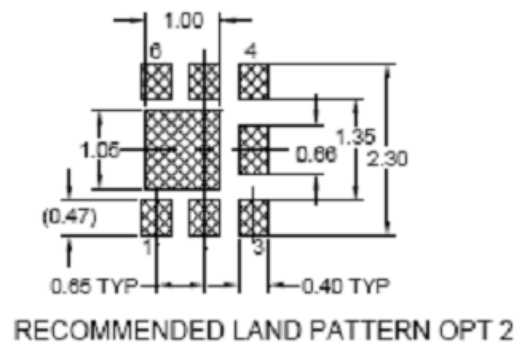
NO DRAIN OR GATE TRACES ALLOWED IN THIS AREA

RECOMMENDED LAND PATTERN OPT 2

PIN#1 LOCATION

PIN #1 IDENT

SEATING PLANE

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SHANGHAI SINO-IC MICROELECTRONICS CO., LTD

Add: Building 3, Room 3401-03, No.200 Zhangheng Road, ZhangJiang Hi-Tech Park, Pudong, Shanghai 201203, China

Phone: +86-21-33932402   33932403

33932405 33933508 33933608

Fax: +86-21-33932401

Email: webmaster@sino-ic.com

Website: http://www.sino-ic.com

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